

	SPECIFICATIONS					
CUSTOMER	· PTC					
SAMPLE CODE	SH800480T0	SH800480T013-IBB01				
MASS PRODUCTION CODE	PH800480T	PH800480T013-IBB01				
SAMPLE VERSION	· 01					
SPECIFICATIONS EDITION	. 006	. 006				
DRAWING NO. (Ver.)	JLMD-PH80	. JLMD-PH800480T013-IBB01_002				
PACKAGING NO. (Ver.)	JPKG-PH80					
	Customer Approved	Date:				
Approved	Checked	Designer				

Approved	Checked	Designer
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Preliminary specification for design input

Specification for sample approval

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History of Version

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
02/28/2015	01	001	New Drawing	-	張斌
04/09/2015	01	002	New Sample	-	張斌
05/19/2015	01	003	Modify LCM Drawing	Appendix	張斌
08/25/2015	01	004	Show Backlight Life Time	9	張斌
03/30/2018	01	005	Modify Backlight Life Time	9	楊威
09/10/2019	01	006	Modify DC Electrical Characteristics Update LCM Packaging	5 Appendix	任健
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LCM Drawing LCM Packaging



1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	800 * (RGB) * 480
LCD Type	a-Si TFT, Normally white, Transmissive type
Screen size(inch)	7.0 inch
Viewing Direction	6 O'clock
Backlight Type	LED B/L
Weight	-
Interface	RGB Interface
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer website :
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	164.9 (W) * 100.0 (L) *4.95 (H)	mm

LCD panel

Item	Standard Value	Unit
Active Area	154.08 (W) * 85.92 (L)	mm

Note: For detailed information please refer to LCM drawing.



1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit	Remark
	DVDD		-0.3	5.0	V	
	AV _{DD}	GND=0	6.5	13.5	V	
Power Supply Voltage	V _{GH}		-0.3	40	V	
	Vgl	AGND=0	-20	0.3	V	
	V _{GH} - V _{GL}	-	0	40	V	
Operating Temperature	T _{OP}	-	-20	70	°C	
Storage Temperature	Tst	-	-30	80	°C	

The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

1.4 DC Electrical Characteristics

GND = 0V, Ta = 25°C

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
	DV _{DD}	3.0	3.3	3.6		
Supply Voltago	V _{GH}	15.3	16.0	16.7	V	
Supply Voltage	Vgl	-7.7	-7.0	-6.3	v	
	AVDD	10.2	10.4	10.6		-
VCOM	Vсом		4.0	-	V	
Input signal Valtage	VIH	0.7DVDD	-	DVDD	V	
Input signal Voltage	VIL	0	-	0.3DV _{DD}	v	
	I (DV _{DD})	-	3.0	-		Pattern= Full display
		-	4.0	10		Pattern= Red *1
Supply Current	$1(\Delta)(-1)$	-	15	-	m۸	Pattern= Full display
Supply Current	I (AV _{DD})	-	20	50	mA	Pattern= Red
	Ідн	-	02	1.0		Pattern= Red
	Igl	-	0.2	1.0		Pattern= Red

Note1: Maximum current display.



1.5 Optical Characteristics

TFT LCD Module

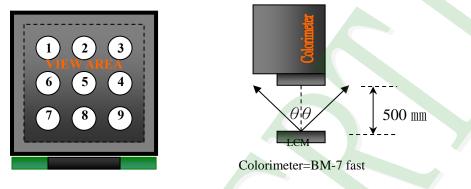
DV_{DD} = 3.3 V, Ta=25°C

IFI LCD Module					L		3.3 V, Ia	<u>1-25 C</u>
Item		Symbol	Condition	Min.	Тур.	Max.	unit	
Response time	Rise	Tr	Tr - 10 20		ma	Note 2		
Response line	Fall	Tf	-	-	15	30	ms	NOLE 2
	Тор	θΥ+		40	50	-		
	Bottom	θY-	- CR ≥ 10 -	60	70	-	Deg	Note 4
Viewing angle	Left	θX-		60	70	-	Deg.	NOLE 4
	Right	θX+	60	70	-			
Contrast ration	0	CR	-	400	500	-		Note 3
	White	Х		0.25	0.30	0.35		
	vvinte	Y		0.29	0.34	0.39		
	Red	Х		0.53	0.58	0.63		
Color of CIE Coordinate	Reu	Y	lf=160mA	0.30	0.35	0.40		Note1
(With B/L&TP)	Croop	Х	11-100111A	0.30	0.35	0.40] -	NOLET
	Green	Y		0.54	0.59	0.64		
	Dhuo	Х		0.10	0.15	0.20		
	Blue	Y		0.02	0.07	0.12		
Average Brightr	ness							
Pattern=white dis (With B/L&TP	•	IV	lf=160mA	260	400		cd/m ²	Note1
Uniformity (With B/L&TP)		۵B	-	70	-	-	%	Note1



Note 1:

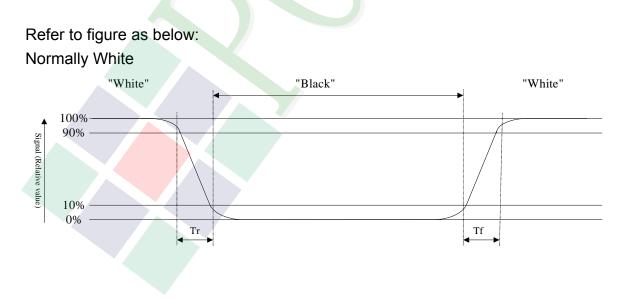
- *1 : △B=B(min) / B(max) * 100%
- *2 : Measurement Condition for Optical Characteristics:
 - a : Environment: 25°C±5°C / 60±20%R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.
 - b : Measurement Distance: 500 ± 50 mm \rightarrow (0= 0°)
 - c : Equipment: TOPCON BM-7 fast , (field 1°) , after 10 minutes operation.
 - d: The uncertainty of the C.I.E coordinate measurement ±0.01 · Average Brightness ± 4%



To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

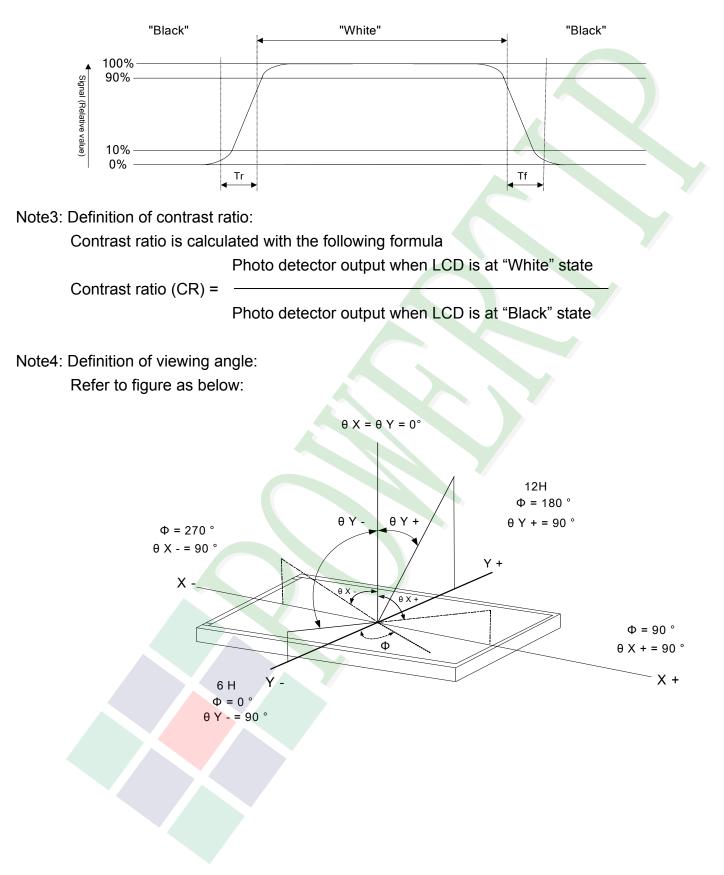
Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white"(falling time) and from "white" to "black"(rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.





Normally Black





1.6 Backlight Characteristics

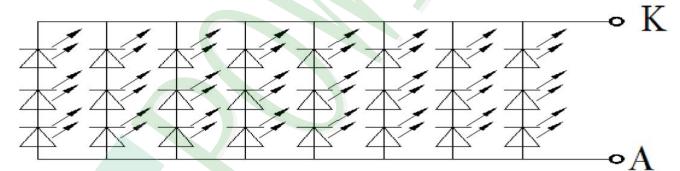
Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
LED Forward Current	IF		-	30*8	mA
LED Reverse Voltage	VR	Ta =25℃	-	5	V
Power consumption	Pd			90*24	mW

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF		9.0	9.6	10.2	-
Average Brightness (Without LCD &T/P)	IV	lf=160mA	8600	10300	13800	cd/m ²
CIE Color Coordinate	Х		0.25	0.28	0.31	
(Without LCD &T/P)	Y		0.26	0.29	0.32	-
Color	White					

Circuit diagram



Other Description

Item	Conditions	Description
Life Time	Ta =25℃ IF= 160mA	50000 hrs



1.7 Touch Panel Characteristics

1.7.1 Optical Characteristics

Item	Specification
1.Transparency	80% Min

1.7.2 Mechanical Characteristic

ltem	Specification
1.Input Method	Finger or stylus pen
2.Hardness of surface	3H -pressure 500g of ,45deg.
3.Activation Force	250gf less individual point with stylus pen(R0.8)
	Activation force guarantee area:3.0mm inside of Active Area.
4.Linearity Force	150gf less input with stylus pen(R0.8)
	Activation force guarantee area:3.0mm inside of Active Area.

1.7.3 Electrical Characteristics

ltem	Specification					
1.Rated Voltage	DC 5V(DC 7V Max)					
2.Resistance Between	Direction X (Glass side): 500Ω~ 1000Ω					
Terminals.	Direction Y (Film side): 100Ω~ 500Ω					
3.Insulation Resistance	20 MΩ or more (DC 25 V 1min)					
4.Linearity	 ±1.5%. Linearity(%)= ΔV/ (EV-SV) *100. ΔV: The difference between the ideal voltage and measured voltage on the each measuring line. SV: Voltage of starting Points. EV: Voltage of Ending Points. (Test condition refers to 1.7.2 item4) 					
5.Bouncing	<10ms (Tip R 3.75mm, hardness 10°~20°, silicon rubber, 500gf operation : 40 mm/sec)					

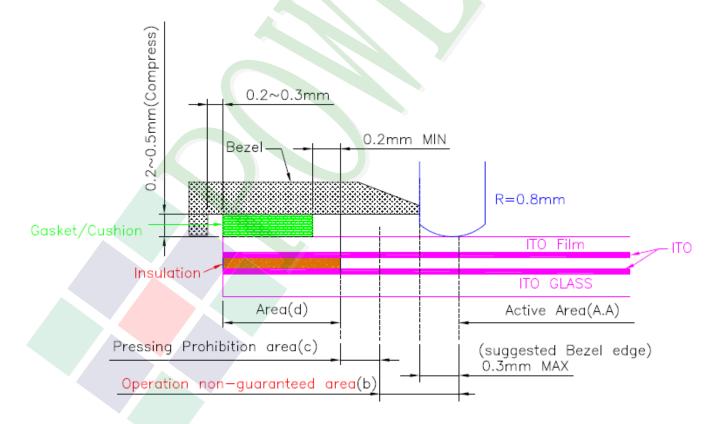


1.7.4 Reliability Characteristic

NO	Test Item	Test Condition	Test Result
	Hitting Durability	1,000,000times min.(R 8 mm	Follow 1.7.3 item2 and item4.
1		Silicon Rubber Hardness 60°	
		250gf 2times/sec).	
2	Pen Sliding Durability	100,000 times min(Tip R0.8mm).	Follow 1.7.3 item2 and item4.
		ψ9mm steel ball is dropped on the	No Crack
3	Impact Resistance	surface from 30 cm height at 1	
		time.	
4	Flexible pattern Bending	Bending 3 times by bending	Follow 1.7.3 item2.
4	Resistance	radius R1.0 mm	



- 1.7.5 Touch Panel Design/Handing Guide
- (1) Keep the gap, for example 0.2 to 0.3mm, between bezel edge and T/P edge. The reason is to avoid the bezel edge from contacting T/P surface that may cause "short" with bottom layer
- (2) Insertion a cushion material is recommended.
- (3) The cushion material should be limited on the busbar insulation paste area. If it is over the transparent insulation paste area, a "short" may be occurred.
- (4) Do not to use an adhesive tape to bond it on the front of T/P and hang it to the housing bezel.
- (5) Never expand the T/P top layer (PET Film) like a balloon by internal air pressure. The life of the T/P will extremely decreasing.
- (6) Top layer, PET, dimension is changing base on environment temperature and humidity. Please avoid a stress from housing bezel to top layer, because it may cause "waving".
- (7) The input to the Touch Panel sometimes distorts touch panel itself.
- (8)To use the stylus pen or fingernail sliding at the edge of the housing is prohibited. It would cause the cracking of the ITO coating and damage the touch panel. It also request not to press this area while assembling
- (9) Purpose: In order to prevent accidental use and performance deterioration, please keep the following precautions.



In order to prevent unusual performance degradation and malfunction of a touch panel, please carry out the set case designing and a touch panel assembling method after surely considering the definition of each area illustrated in above figure.



Area(a) : Active area

The active area is guaranteed the position data detectable precision, operation force and other operations. it is strongly recommended to place the operation button or menu keys within the active area. Due to structure, the active area is less durable at the edge or close to the edge.

Area(b) : Operation non-guaranteed area

This area does not guarantee a touch panel operation and its function. When this area is pressed, touch panel shows degradation of its performance and durability such as a pen sliding durability becomes about one-tenth compared with the active area (area-(a) as guaranteed area) and its operation force requires about double. About 0.5 mm outside from a boundary of the active area corresponds to this area.

Area(c) : Pressing prohibition area

The area which forbids pressing, because an excessive load is applied to a transparent electrode (ITO) and a serious damage is given to a touch panel function by pressing. About 0.5 mm outside from Operation non-guaranteed area .

Area(d) : Non-Active area The area does not activate even if pressed.



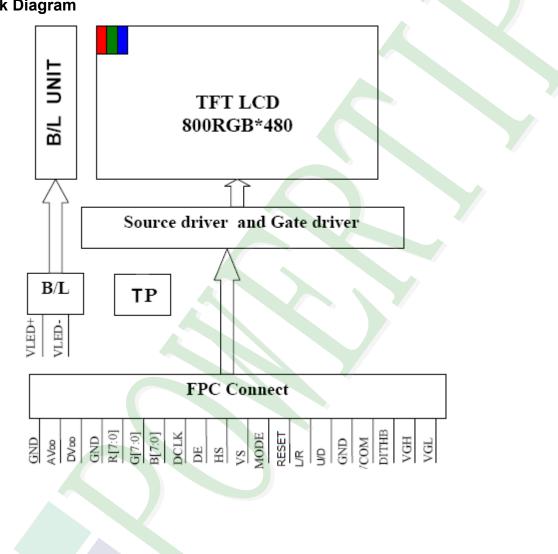
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





2.2 Interface Pin Description

Pin NO.	SYMBOL	DESCRIPTION	Type:Remark
1	V_{LED^+}	Power For LED backlight (+).	Power
2	V _{LED+}	Power For LED backlight (+).	Power
3	V_{LED}	Power For LED backlight (-).	Power
4	V_{LED}	Power For LED backlight (-).	Power
5	GND	Power ground.	Power
6	V _{com}	Common voltage.	
7	DVDD	Power for Digital Circuit.	
8	MODE	DE/SYNC mode select.	I,Note 1
9	DE	Data Input Enable.	I
10	VS	Vertical Sync Input.	I
11	HS	Horizontal Sync Input.	I
12	B7	Blue Data(MSB).	1
13	B6	Blue Data.	
14	B5	Blue Data.	I
15	B4	Blue Data.	I
16	B3	Blue Data.	I
17	B2	Blue Data.	I
18	B1	Blue Data.	I:Note 2
19	B0	Blue Data(LSB).	I:Note 2
20	G7	Green Data(MSB).	I
21	G6	Green Data.	I
22	G5	Green Data.	I
23	G4	Green Data.	I
24	G3	Green Data.	l
25	G2	Green Data.	I
26	G1	Green Data.	I:Note 2
27	G0	Green Data(LSB).	I:Note 2
28	R7	Red Data(MSB).	I
29	R6	Red Data.	I
30	R5	Red Data.	I
31	R4	Red Data.	I
32	R3	Red Data.	I
33	R2	Red Data.	I
34	R1	Red Data.	I:Note 2
35	R0	Red Data(LSB).	I:Note 2
36	GND	Power Ground	Power
37	DCLK	Sample clock	I:Note 3



Pin NO.	SYMBOL	DESCRIPTION	Type:Remark
38	GND	Power Ground.	Power
39	L/R	Left / right selection.	I:Note 4
40	U/D	Left / right selection.	I:Note 4
41	V _{GH}	Gate On Voltage.	Power
42	Vgl	Gate OFF Voltage.	Power
43	AV _{DD}	Power for Analog Circuit.	Power
44	RESET	Global reset pin.	I:Note 5
45	NC	No connection.	-
46	V _{COM}	Common Voltage.	
47	DITHB	Dithering Function.	I:Note 6
48	GND	Power Ground.	Power
49	NC	No connection.	-
50	NC	No connection.	-

I: input

Note 1: DE/SYNC mode select. Normally pull high.

When select DE mode, MODE="1", VS and HS must pull high.

When select SYNC mode, MODE= "0", DE must be grounded.

Note 2: When input 18 bits RGB data, the two low bits of R,G and B data must be grounded.

Note 3: Data shall be latched at the falling edge of DCLK.

Note 4: Selection of scanning mode.

Setting of scan of	control input	Scanning direction
U/D	L/R	
GND	DVDD	Up to down, left to right
DVDD	GND	Down to up, right to left
GND	GND	Up to down, right to left
DVDD	DVDD	Down to up, left to right

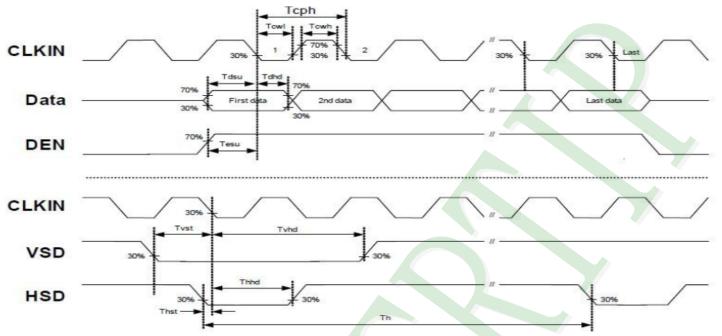
Note 5: Global reset pin. Active low to enter reset state. Suggest to connect with an RC reset circuit for stability. Normally pull high.

Note 6: Dithering function enable control, normally pull high. When DITHB="1",Disable internal dithering function. When DITHB="0",Enable internal dithering function.



2.3 Timing Characteristics

2.3.1 Signal AC Characteristics



lite and	Or make al	Values			l Imit	it Domork
Item	Symbol	Min	Тур	Max.	Unit	Remark
HS setup time	Thst	8	-	-	ns	
HS hold time	Thhd	8	-	-	ns	
VS setup time	Tvst	8	-	-	ns	
VS setup time	Tvhd	8	-	-	ns	
VS setup time	Tdsu	8	-	-	ns	
VS setup time	Tdhd	8	-	-	ns	
DE setup time	Tesu	8	-	-	ns	
DE hole time	Tehd	8	-	-	ns	
DVDD Power On Slew rate	TPOR	-	-	20	ms	From 0 to 90%DVpp
RESET pulse width	TRst	1	-	-	ms	
DCLK cycle time	Tcoh	20	-	-	ns	
DCLK pulse duty	Tcwh	40	50	60	%	

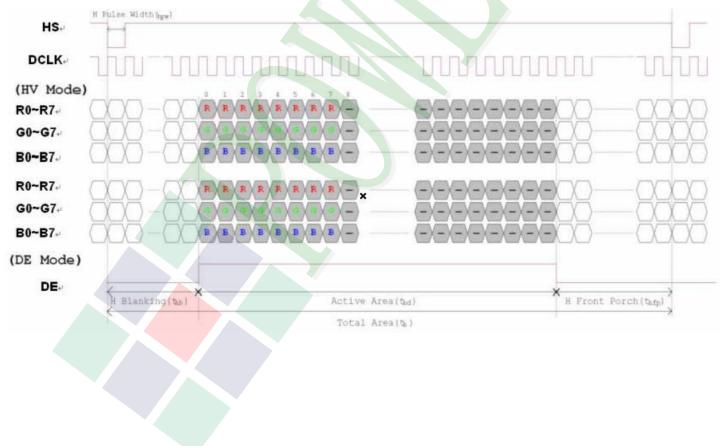


2.3.2 Input Timing Setting

Item	Symbol	Values			Unit	Remark
		Min.	Тур.	Max.		
Horizontal Display Area	Thd		800		DCLK	
DCLK Frequency	Fclk	26.4	33.3	46.8	MHz	
One Horizontal Line	Th	862	1056	1200	DCLK	
HS pulse width	Thpw	1		40	DCLK	
HS Blanking	Thb	46	46	46	DCLK	
HS Front Porch	Thfp	16	210	354	DCLK	

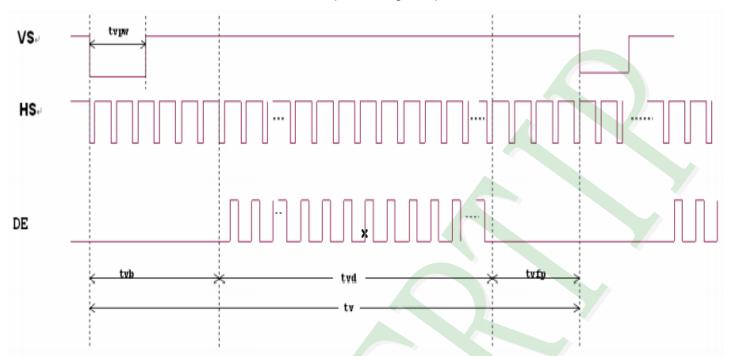
ltem	Symbol		Values		Unit	Remark
		Min.	Тур.	Max.		
Vertical Display Area	Tvd		480		TH	
VS period time	Τv	510	525	650	TH	
VS pulse width	Tvpw	1		20	ΤH	
VS Blanking	Tvb	23	23	23	TH	
VS Front Porch	T∨fp	7	22	147	TH	

Horizontal input timing diagram





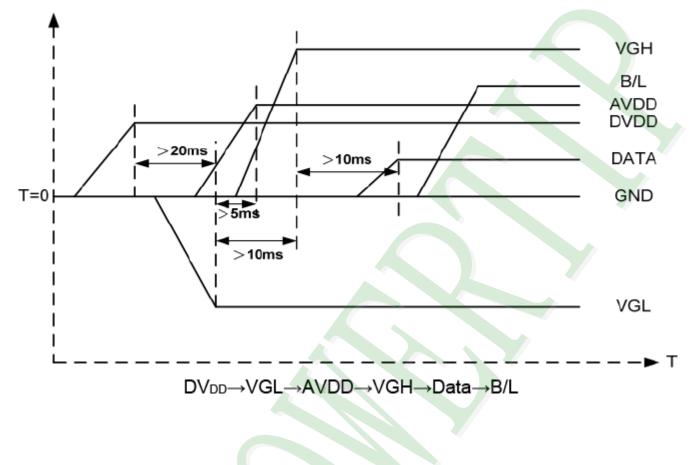
Vertical input timing diagram



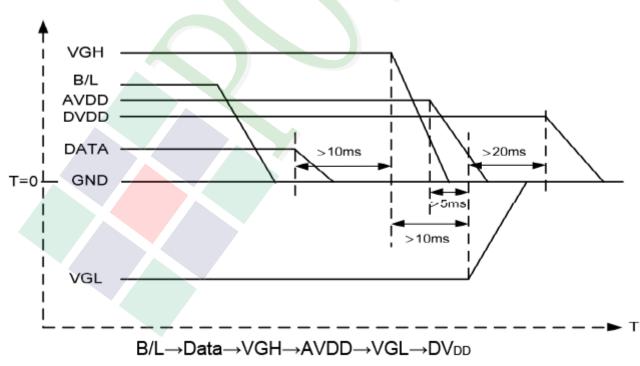


2.3.3 Power On/Off Characteristics





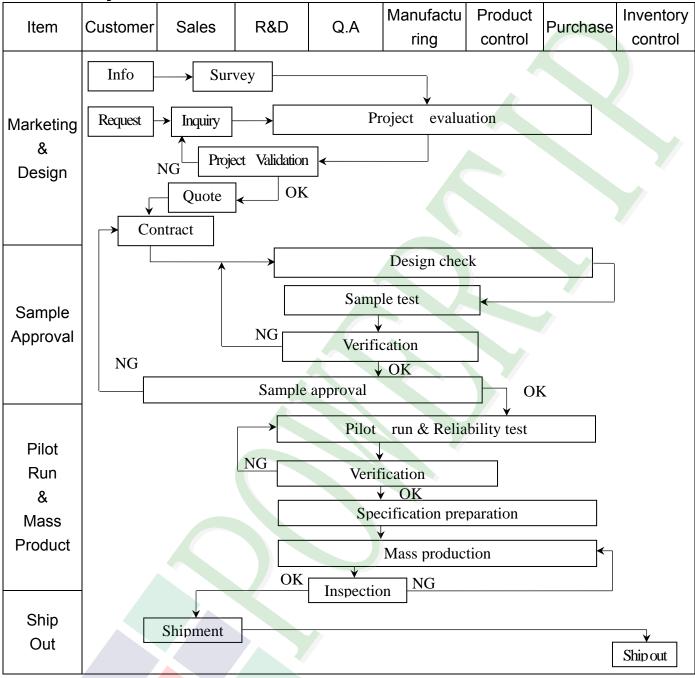
b. Power off:





3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart



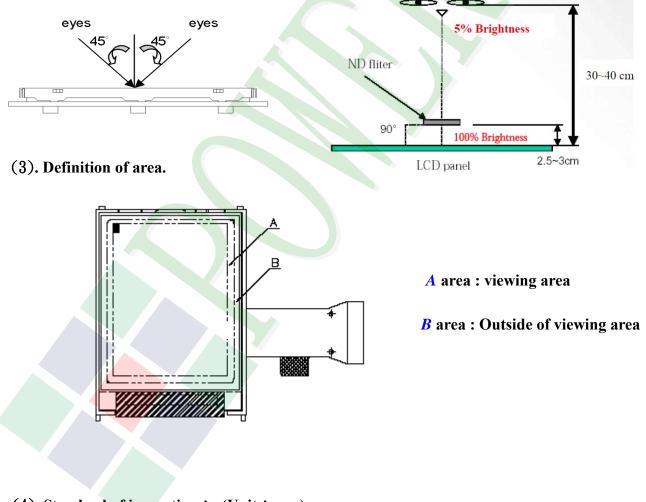


Item	Customer	Sales	R&D	Q.A	Manufact uring	Product control	Purchase	Inventory control
Sales Service	Info	Claim	[Trackin	Failure an Corrective			
Q.A Activity	1. ISO 900 3. Equipme 5. Standard	ent calibrati	on	4	Process in Education	•		es

POWERTIP

3.2 Inspection Specification

- Scope : The document shall be applied to TFT-LCD Module for 3. 5" ~15" (Ver.B01).
- ◆Inspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- Equipment : Gauge \ MIL-STD \ Powertip Tester \ Sample
- ◆Defect Level : Major Defect AQL : 0.4 ; Minor Defect AQL : 1.5
- **OUT Going Defect Level : Sampling.**
- **♦**Standard of the product appearance test :
 - a. Manner of appearance test :
 - (1). The test best be under 20W×2 fluorescent light(about 300lux ~500lux)
 - and distance of view must be at 30~40 cm.
 - (2). The test direction is base on about around 45° of vertical line.





◆Specification For TFT-LCD Module 3. 5″~15″:

◆Specification For TFT-LCD Module 3. 5″~15″: (Ve							
NO	Item	Criterion	Level				
		1. 1The part number is inconsistent with work order of production.					
01	Product condition	1. 2 Mixed product types.	Major				
		1. 3 Assembled in inverse direction.	Major				
02	Quantity	2. 1The quantity is inconsistent with work order of production.	Major				
03	Outline dimension	3.1 Product dimension and structure must conform to structure diagram.	Major				
		4. 1 Missing line character and icon.	Major				
		4. 2 No function or no display.	Major				
0.4	Electrical Testing	4. 3 Display malfunction.					
04		4. 4 LCD viewing angle defect.					
		4. 5 Current consumption exceeds product specifications.					
		4. 6 Mura can not be seen through 5% ND filter at 50% Gray screen , should be judged by the viewing angle of 90 degree.					
		Item Acceptance (Q'ty)					
		Bright Dot ≤ 4					
	Dot defect	Dot Dark Dot ≤ 5					
		Defect Joint Dot ≤ 3					
05	(Bright dot \ Dark dot)	Total ≤ 7	Minor				
	On -display	 5. 1 Inspection pattern : full white , full black , Red , Green and blue screens. 5. 2 It is defined as dot defect if defect area >1/2 dot. 5. 3 The distance between two dot defect ≥5 mm. 5. 4 Bright dot that can not be seen through 5% ND filter. 					



♦ Spe	cification For TFT	F-LCD Module 3. 5″~15″:	(Ver.B01)			
NO	Item	Criterion				
06	Black or white dot \cdot scratch \cdot contamination Round type $\downarrow X \qquad \downarrow Y \qquad \downarrow$ $\Phi = (x+y)/2$ Line type $\downarrow L \qquad \downarrow W \qquad \downarrow$	6. 1 Round type (Non-display or display) : $ \frac{Dimension (diameter : \Phi) \\ A area \\ B area \\ \hline \Phi \le 0.25 \\ \hline Ignore \\ \hline 0.25 < \Phi \le 0.50 \\ \hline 0 > 0.50 \\ \hline 0 > 0.50 \\ \hline 0 > 0.50 \\ \hline 0 \\ \hline Total \\ 5 \\ \hline \end{array} $ 6. 2 Line type(Non-display or display) : 6. 2 Line type(Non-display or display) : $ module size \\ Length \\ (L) \\ \hline Width (W) \\ A area \\ \hline B area \\ \hline \\ W \le 0.03 \\ Ignore \\ \hline L \le 10.0 \\ 0.03 < W \le 0.05 \\ 4 \\ L \le 5.0 \\ 0.05 < W \le 0.10 \\ 2 \\ \hline \\ W > 0.10 \\ type \\ \hline 0 \\$	Minor			
07	Polarizer Bubble	Dimension (diameter : Φ)Acceptance (Q'ty)A areaB area $\Phi \leq 0.25$ Ignore $0.25 < \Phi \leq 0.50$ 4 $0.50 < \Phi \leq 0.80$ 1Ignore $\Phi > 0.80$ $\Phi > 0.80$ 0Total5	Minor			



◆Specification For TFT-LCD Module 3. 5″~15″:

◆Specification For TFT-LCD Module 3. 5″~15″:				
NO	Item	Criterion		
		Z : The thickness of crack	Y : The width of crack. W : terminal length a : LCD side length	
		8.1 General glass chip: 8.1.1 Chip on panel surface and cra	nck between panels:	
		Y Z Z	Y	
08	The crack of glass	SP Y [OK]	ING]	Minor
		Seal width	Y	
		XY	Z	
		≤ a Crack can't enter viewing area	≦1/2 t	
		$\leq a \qquad \begin{array}{c} Crack can't exceed the \\ half of SP width. \end{array}$	$1/2 t < Z \leq 2 t$	

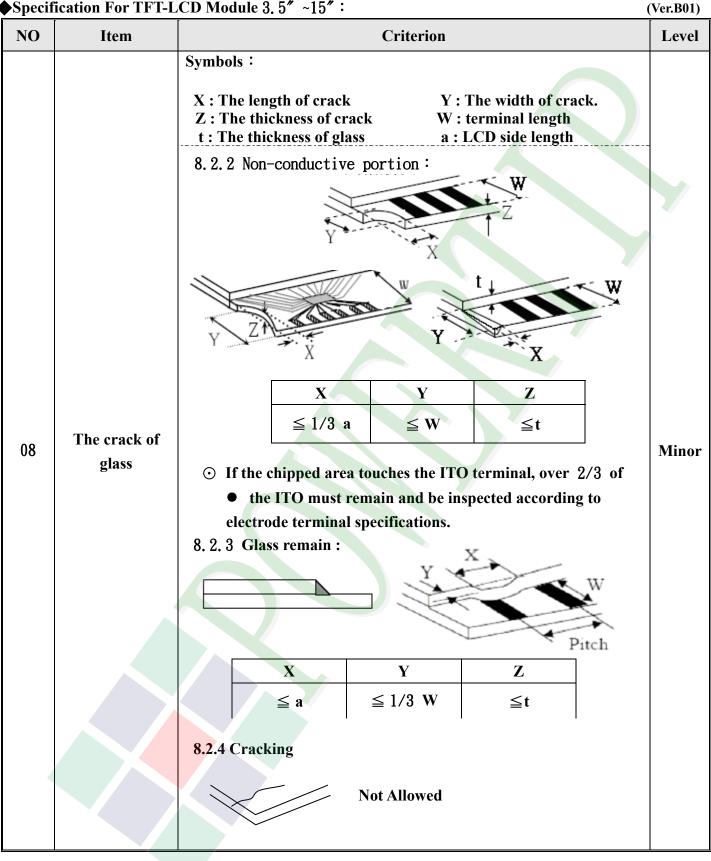


◆Specification For TFT-LCD Module 3, 5″~15″:

◆Specification For TFT-LCD Module 3. 5″~15″: (Ver						
NO	Item	Criterion				
		Symbols : X : The length of crack Y : The width of crack. Z : The thickness of crack W : terminal length t : The thickness of glass a : LCD side length 8. 1. 2 Corner crack : X - Z - Z - Z - Z - Z - Z - Z - Z - Z -				
		XYZ $\leq 1/5$ aCrack can't enter viewing areaZ $\leq 1/2$ t				
		$ \leq 1/5 \text{ a} \begin{array}{ c c } \text{Crack can't exceed the} \\ \text{half of SP width.} \end{array} 1/2 \text{ t} < \text{Z} \leq 2 \text{ t} \\ \end{array} $				
08	The crack of glass 8.2 Protrusion over terminal:					
		8.2.1 Chip on electrode pad: X Y Z X Y Z Z X Y Z Z Z X Y Z				
		XYZFront $\leq a$ $\leq 1/2$ W $\leq t$				
		Back $\leq a$ $\leq W$ $\leq 1/2 t$				



◆Specification For TFT-LCD Module 3. 5″~15″:





◆Specification For TFT-LCD Module 3. 5″~15″:

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NO	Item	Criterion	Level
	Backlight elements	9. 1 Backlight can't work normally.	Major
09		9. 2 Backlight doesn't light or color is wrong.	Major
		9. 3 Illumination source flickers when lit.	Major
	General appearance	10. 1 Pin type \ quantity \ dimension must match type in structure diagram.	Major
		10. 2 No short circuits in components on PCB or FPC .	Major
		10.3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major
10		10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≤1.5 mm.	Minor



4. RELIABILITY TEST

4.1 Reliability Test Condition

(Ver.B01)

4.	Reliability lest Condition (Ver.BU				<u>,,,,,</u>	
NO.	TEST ITEM	TEST CONDITION				
1	High Temperature Storage Test	Keep in +80 ±2℃ 240 hrs Surrounding temperature, then storage at normal condition 4hrs.				
2	Low Temperature Storage Test	Keep in −30 ±2°C 240 hrs Surrounding temperature, then storage at normal condition 4hrs.				
3	High Temperature / High Humidity Storage Test	Keep in +60°C / 90% R.H duration for 240 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)				
4	Temperature Cycling Storage Test		$-30^{\circ} C \rightarrow +25^{\circ} C \rightarrow$ (30mins) (5mins)			
		20 Cycle Surrounding temperature, then storage at normal condition 4hrs.			hva	
		Air Dischar		Contact Discharge:		
			with 5 times	Apply 250 V with 5 times		
	ESD Test		or each polarity +/-		y +/-	
5		 Temperature ambiance : 15°C ~35°C Humidity relative : 30%~60% Energy Storage Capacitance(Cs+Cd) : 150pF±10% Discharge Resistance(Rd) : 330 Ω±10% Discharge, mode of operation : Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication : ±5%) 				
6	Vibration Test (Packaged)	 Sine wave 10~55 Hz frequency (1 min) The amplitude of vibration :1.5 mm Each direction (X \ Y \ Z) duration for 2 Hrs 				
	Drop Test (Packaged)		Packing Weight (Kg)	Drop Height (cm)		
			0 ~ 45.4	122		
			45.4 ~ 90.8	76		
7			90.8 ~ 454	61		
			Over 454	46		
		Drop direct	ion :※1 corner / 3 edg	es / 6 sides each 1times		



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—when working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is $320\pm10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.
- 5.2.10 Caution! (LCM products with Capacitive Touch Panel) Strong EMI-sources such as switch-mode power supplies (SMPS) can lead to touch malfunction (e.g. ghost-touches).

Therefore, the touch needs to be thoroughly tested inside the target application.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is $25^{\circ}_{\circ} \pm 5^{\circ}_{\circ}$ and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

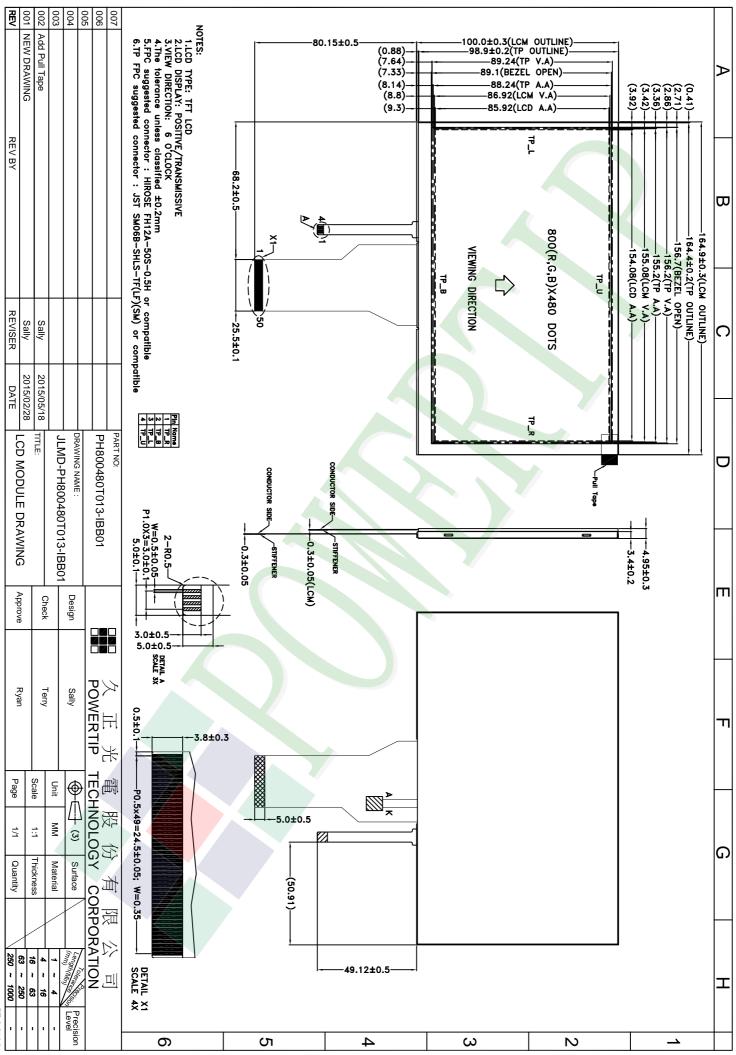
5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

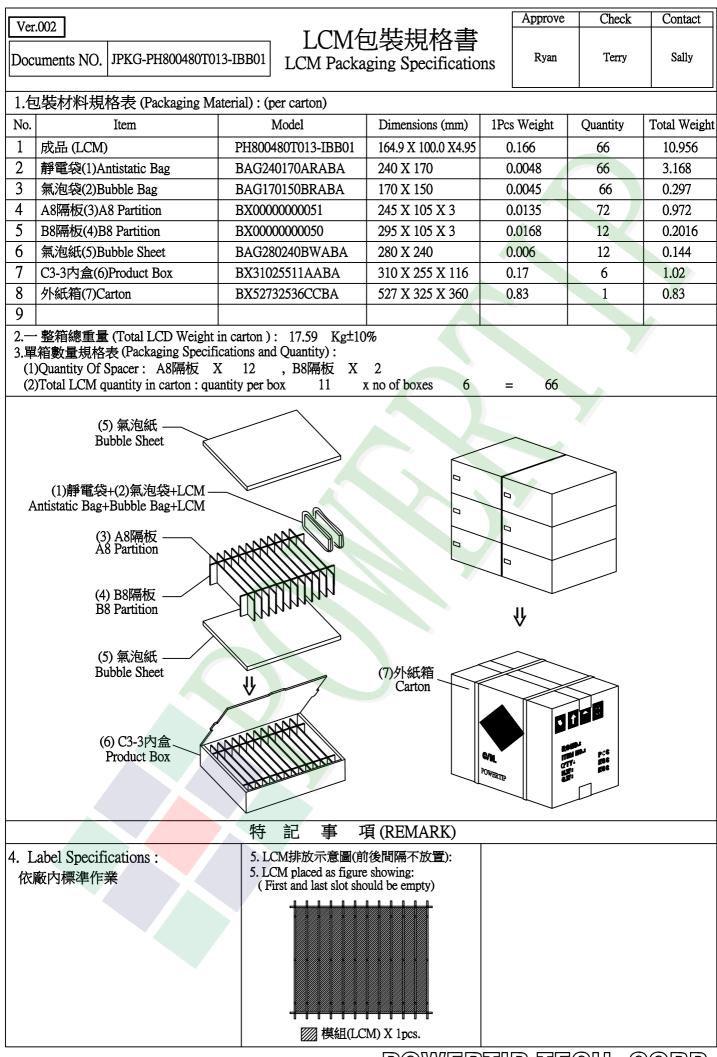
The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



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